

P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY

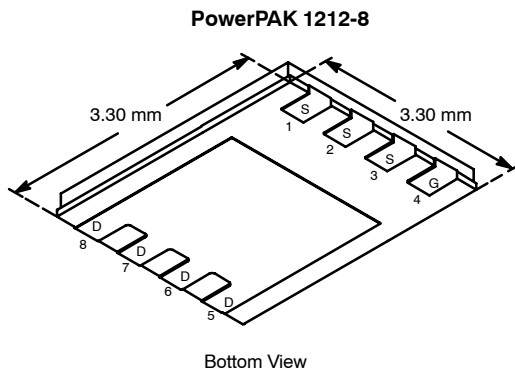
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
-12	0.016 @ $V_{GS} = -4.5$ V	-13
	0.022 @ $V_{GS} = -2.5$ V	-11
	0.028 @ $V_{GS} = -1.8$ V	-9.8

FEATURES

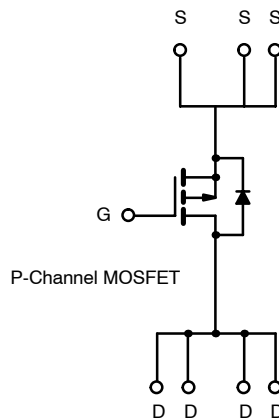
- TrenchFET® Power MOSFETS: 1.8-V Rated
- New PowerPAK® Package
 - Low Thermal Resistance, R_{thJC}
 - Low 1.07-mm Profile

APPLICATIONS

- Load Switch
- Power Switch
- PA Switch



Ordering Information: Si7405DN-T1



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 12		V
Gate-Source Voltage		V _{GS}	± 8		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 25°C	I _D	- 13	- 8.3	A
	T _A = 85°C		- 9.4	- 6.0	
Pulsed Drain Current		I _{DM}	- 30		
continuous Source Current (Diode Conduction) ^a		I _S	- 3.2	- 1.3	
Maximum Power Dissipation ^a	T _A = 25°C	P _D	3.8	1.5	W
	T _A = 85°C		2.0	0.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 10$ sec	R_{thJA}	26	33	$^\circ\text{C/W}$
	Steady State		65	81	
Maximum Junction-to-Case	Steady State	R_{thJC}	1.9	2.4	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

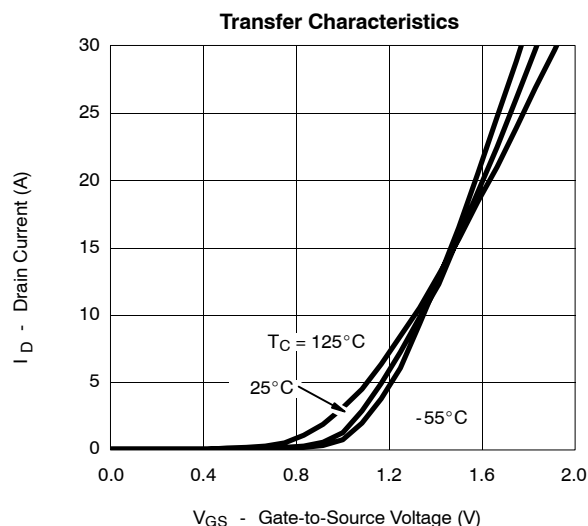
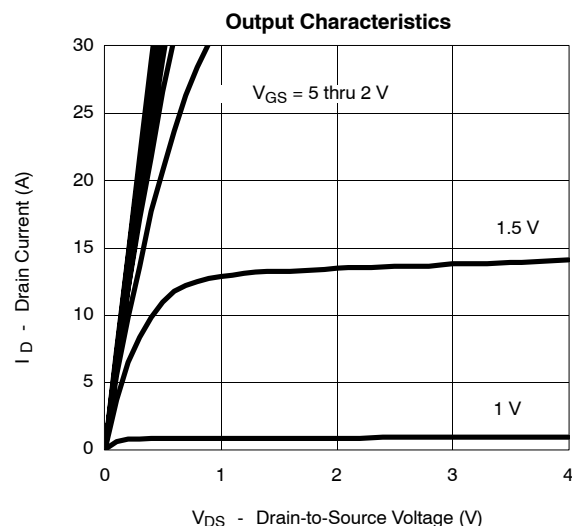
SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -2\text{ mA}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -12\text{ V}, V_{GS} = 0\text{ V}$			-1	μA
		$V_{DS} = -12\text{ V}, V_{GS} = 0\text{ V}, T_J = 85^\circ\text{C}$			-5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \leq -5\text{ V}, V_{GS} = -4.5\text{ V}$	-30			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -13\text{ A}$		0.013	0.016	Ω
		$V_{GS} = -2.5\text{ V}, I_D = -11\text{ A}$		0.018	0.022	
		$V_{GS} = -1.8\text{ V}, I_D = -3\text{ A}$		0.022	0.028	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -6\text{ V}, I_D = -13\text{ A}$		35		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -3.2\text{ A}, V_{GS} = 0\text{ V}$		-0.7	-1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -6\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -13\text{ A}$		35	50	nC
Gate-Source Charge	Q_{gs}			6.6		
Gate-Drain Charge	Q_{gd}			7.7		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}, R_L = 6\text{ }\Omega$ $I_D \cong -1\text{ A}, V_{GEN} = -4.5\text{ V}, R_G = 6\text{ }\Omega$		25	40	ns
Rise Time	t_r			50	75	
Turn-Off Delay Time	$t_{d(off)}$			175	260	
Fall Time	t_f			150	225	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -3.2\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		30	60	

Notes

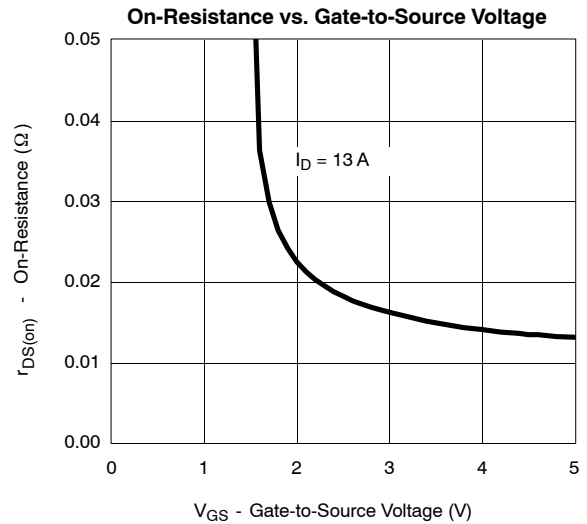
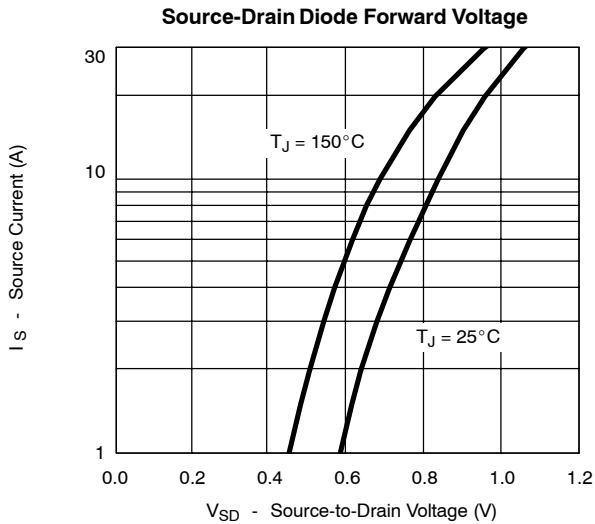
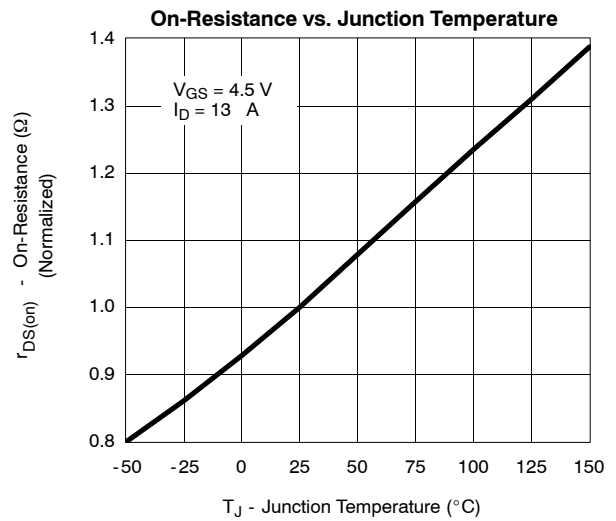
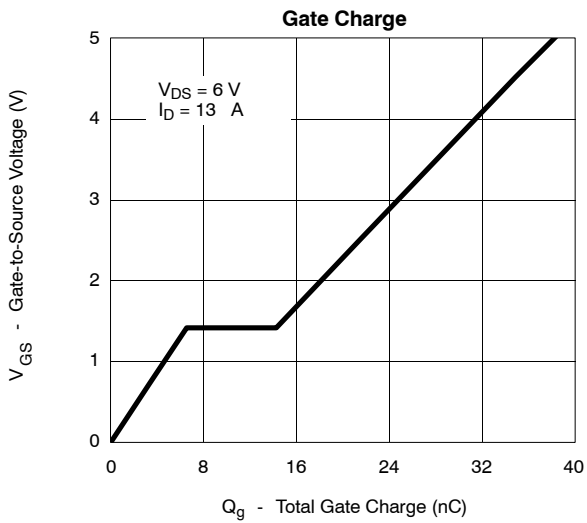
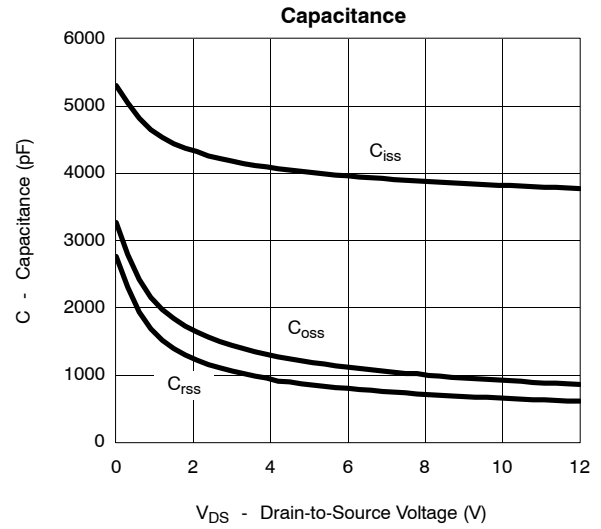
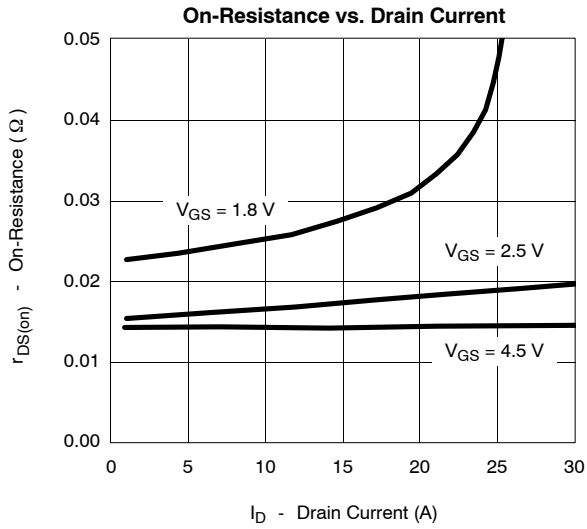
a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



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